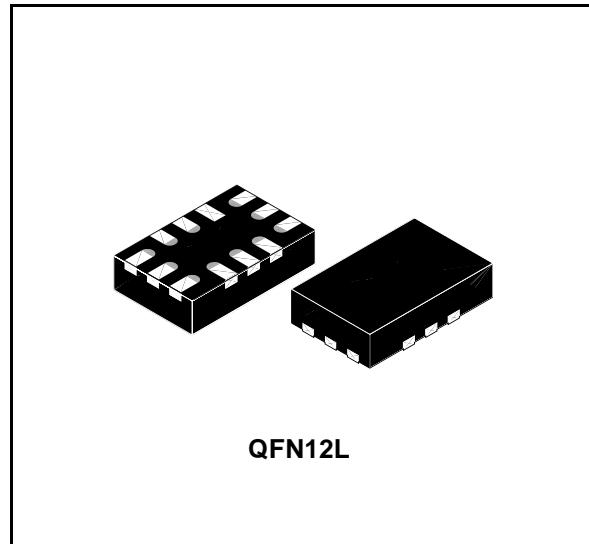


## Low Voltage 1.0Ω Max Dual SP3T Switch With Break Before Make Feature

### TARGET SPECIFICATION

#### Features

- HIGH SPEED:
  - $t_{PD} = 0.3\text{ns}$  (TYP.) at  $V_{CC} = 3.0\text{V}$
  - $t_{PD} = 0.4\text{ns}$  (TYP.) at  $V_{CC} = 2.3\text{V}$
- ULTRA LOW POWER DISSIPATION:
  - $I_{CC} = 0.2\mu\text{A}$  (MAX.) at  $T_A = 85^\circ\text{C}$
- LOW "ON" RESISTANCE  $V_{IN} = 0\text{V}$ :
  - $R_{ON} = 1.0\Omega$ (MAX.  $T_A = 25^\circ\text{C}$ ) AT  $V_{CC}=4.3\text{V}$
  - $R_{ON} = 1.5\Omega$ (MAX.  $T_A = 25^\circ\text{C}$ ) AT  $V_{CC}=3.0\text{V}$
  - $R_{ON} = 1.8\Omega$ (MAX.  $T_A = 25^\circ\text{C}$ ) AT  $V_{CC}=2.3\text{V}$
- WIDE OPERATING VOLTAGE RANGE:
  - $V_{CC}$  (OPR) = 1.65V to 4.3V SINGLE SUPPLY
- 4.3V TOLERANT AND 1.8V COMPATIBLE THRESHOLD ON DIGITAL CONTROL INPUT at  $V_{CC} = 2.3$  TO 4.3V
- LATCH-UP PERFORMANCE EXCEEDS 300mA (JESD 17)
- ESD PERFORMANCE (ANALOG CHAN. Vs. GND): HBM >2kV (MIL STD 883 method 3015)



#### Description

The STG3856 is a high-speed CMOS LOW VOLTAGE DUAL ANALOG S.P.3.T. (Single Pole Triple Throw) SWITCH or Dual 3:1 Multiplexer / Demultiplexer Switch fabricated in silicon gate C<sup>2</sup>MOS technology. It is designed to operate from 1.65V to 4.3V, making this device ideal for portable applications.

The device offers very low ON-Resistance (<1.0Ω) at  $V_{CC} = 4.3\text{V}$ . The disabling and enabling of switches are done by setting the 1IN and 2IN control pins. Additional key features are fast switching speed, and Ultra Low Power Consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

#### Order Codes

Part Number	Temperature Range	Package	Comments
STG3856	-40°C to +85°C	QFN12L (2.2mm x 1.4mm)	STG3856QTR

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# 1 Summary Description

## 1.1 Pin Connections and Description

Figure 1. Connection Diagramm (Top through view)

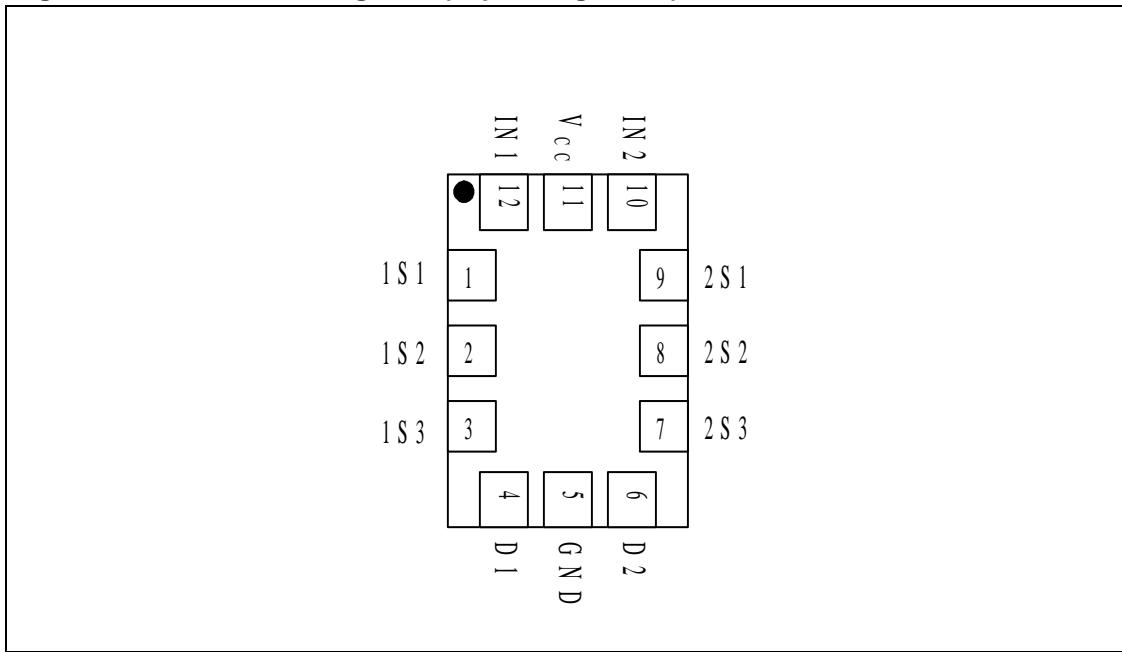


Table 1. Pin Description

Pin N°	Symbol	Name and Function
12, 10	1IN, 2IN	Controls
1,2,3, 9,8,7	1S1, 1S2, 1S3, 2S1, 2S2, 2S3	Independent Channels
4,6	D1, D2	Common Channels
11	V <sub>CC</sub>	Positive Supply Voltage
5	GND	Ground (0V)

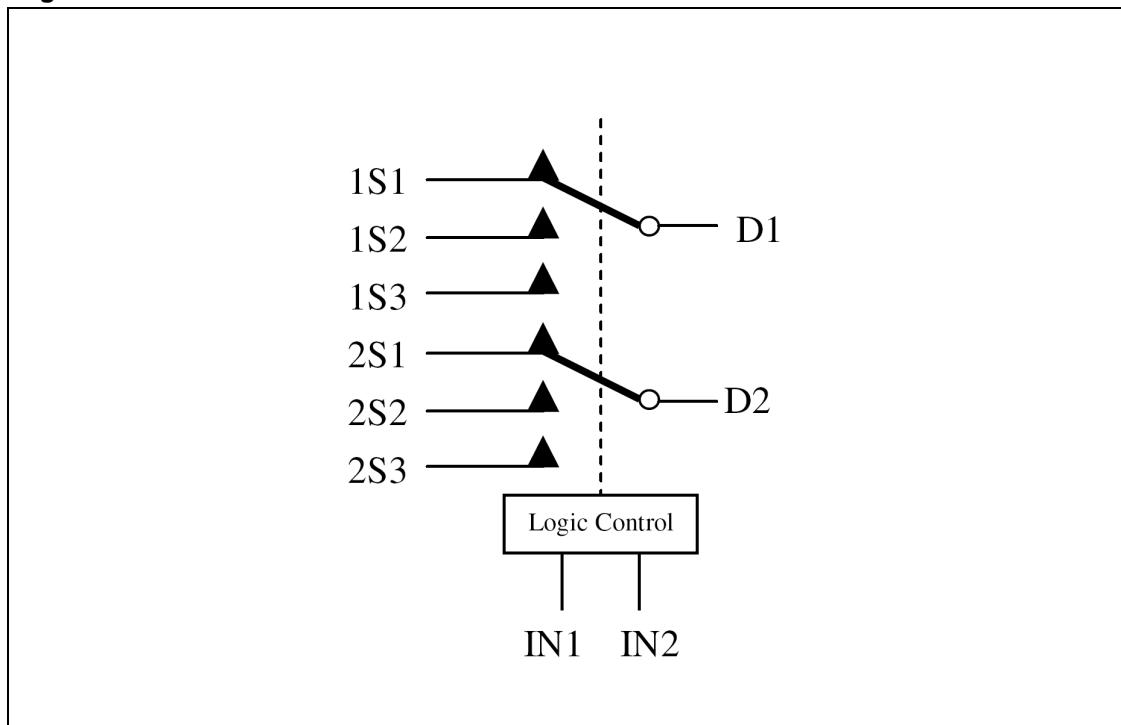
## 1.2 Truth Table

Table 2. Truth Table

1IN	2IN	Switch State
L	L	High-Impedance
L	H	D1-1S1, D2-2S1
H	L	D1-1S2, D2-2S2
H	H	D1-1S3, D2-2S3

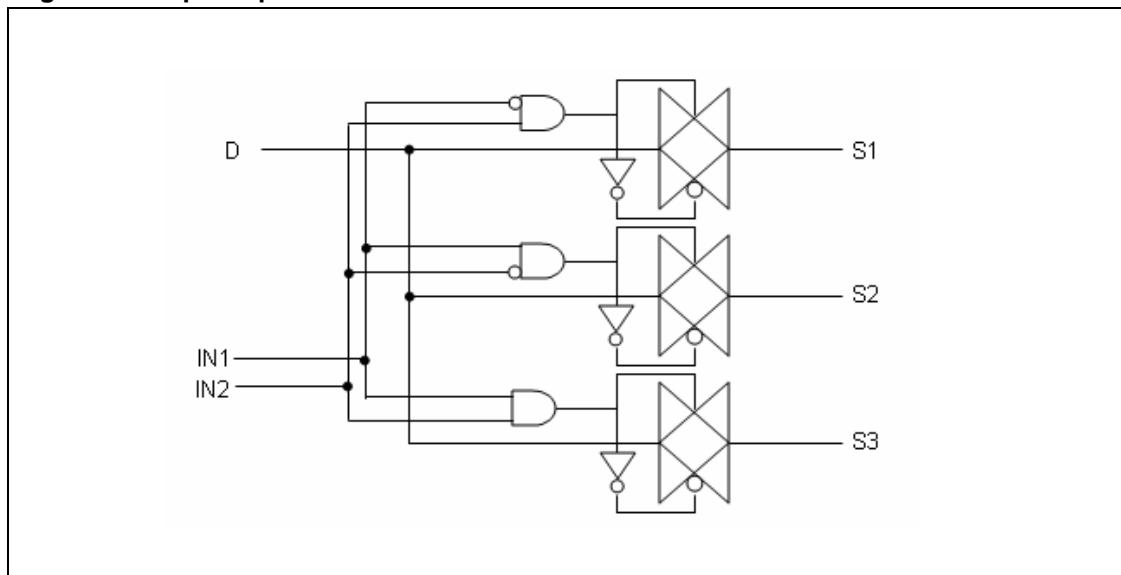
### 1.3 Internal Schematic

Figure 2. Internal Schematic



### 1.4 Input Equivalent Circuit

Figure 3. Input Equivalent Circuit



## 2 Maximum Ratings

Stressing the device above the rating listed in the “Absolute Maximum Ratings” table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

**Table 3. Absolute Maximum Ratings**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage	-0.5 to 5.5	V
$V_I$	DC Input voltage	-0.5 to $V_{CC} + 0.5$	V
$V_{IC}$	DC Control Input Voltage	-0.5 to 5.5	V
$V_O$	DC Output Voltage	-0.5 to $V_{CC} + 0.5$	V
$I_{IKC}$	DC Input Diode Current on Control Pin ( $V_{IN} < 0V$ )	-50	mA
$I_{IK}$	DC Input Diode Current ( $V_{IN} < 0V$ )	$\pm 50$	mA
$I_{OK}$	DC Output Diode Current	$\pm 20$	mA
$I_O$	DC Output Current	$\pm 150$	mA
$I_{OP}$	DC Output Current Peak (pulse at 1ms, 10% duty cycle)	$\pm 300$	mA
$I_{CC}$ or $I_{GND}$	DC $V_{CC}$ or Ground Current	$\pm 100$	mA
$P_D$	Power Dissipation at $T_A = 70^\circ\text{C}$ <sup>(1)</sup>		mW
$T_{STG}$	Storage Temperature	-65 to 150	$^\circ\text{C}$
$T_L$	Lead Temperature (10 sec)	300	$^\circ\text{C}$

1. Derate above  $70^\circ\text{C}$  by 18.5mW/C

### 3 Electrical Characteristics

**Table 4. Recommended Operating Conditions**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply Voltage <sup>(1)</sup>	1.4 to 4.3	V
$V_I$	Input Voltage	0 to $V_{CC}$	V
$V_{IC}$	Control Input Voltage	0 to $V_{CC}$	V
$V_O$	Output Voltage	0 to $V_{CC}$	V
$T_{OP}$	Operating Temperature	-55 to 125	°C
$dV/dt$	Input rise and Fall Time Control Input	$V_{CC} = 1.65V$ to 2.7V	0 to 20
		$V_{CC} = 3.0$ to 4.3V	0 to 10
			ns/V

1. Truth Table guaranteed: 1.2V to 4.3V

#### 3.1 DC Electrical Characteristics

**Table 5. DC Electrical Characteristics**

Symbol	Parameter	Test Condition		Value						Unit	
		$V_{CC}$ (V)		$T_A = 25^\circ C$			$-40$ to $85^\circ C$		$-55$ to $125^\circ C$		
				Min.	Typ.	Max.	Min.	Max.	Min.		
$V_{IH}$	High Level Input Voltage	1.65-1.95		0.65 $V_{CC}$			0.65 $V_{CC}$		0.65 $V_{CC}$	V	
		2.3 - 2.5		1.4			1.4		1.4		
		2.7 - 3.0		1.4			1.4		1.4		
		3.3 - 4.3		1.5			1.5		1.5		
$V_{IL}$	Low Level Input Voltage	1.65-1.95				0.40		0.40		V	
		2.3 - 2.5				0.50		0.50			
		2.7 - 3.0				0.50		0.50			
		3.3 - 4.3				0.50		0.50			
$R_{ON}$	Switch ON Resistance	4.3	$V_S=0V$ to $V_{CC}$ $I_S=100mA$		0.6	1.0		1.2		$\Omega$	
		3.0		1.3	1.5		1.8				
		2.7		1.5	1.8		2.2				
		2.3		2.0	2.2		2.6				
		1.8		2.5	3.0		3.6				
		1.65		3.3	4.0		4.8				
$\Delta R_{ON}$	ON Resistance Match between channels	2.7	$V_S @ R_{ON}$ Max $I_S=100mA$		0.01					$\Omega$	

**Table 5. DC Electrical Characteristics**

Symbol	Parameter	Test Condition		Value						Unit	
		V <sub>CC</sub> (V)		T <sub>A</sub> = 25°C			-40 to 85°C		-55 to 125°C		
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
R <sub>FLAT</sub>	ON Resistance FLATNESS (1)(2)	4.3	V <sub>S</sub> =0V to V <sub>CC</sub> I <sub>S</sub> =100mA								Ω
		3.0									
		2.7			0.22	0.35		0.35			
		2.3									
		1.65									
I <sub>OFF</sub>	OFF State Leakage Current (nSN), (Dn)	4.3	V <sub>S</sub> =0.3 or 4V			±20		±100			nA
I <sub>IN</sub>	Input Leakage Current	0 - 4.3	V <sub>IN</sub> =0 to 4.3V			±0.1		±1			μA
I <sub>CC</sub>	Quiescent Supply Current	1.65 - 4.3	V <sub>IN</sub> =V <sub>CC</sub> or GND			±0.05		±0.2		±1	μA
I <sub>CCLV</sub>	Quiescent Supply Current Low Voltage Driving	4.3	V <sub>IN1</sub> , V <sub>IN2</sub> = 1.65V		±37	±50		±100			μA
			V <sub>IN1</sub> , V <sub>IN2</sub> = 1.80V		±33	±40		±50			
			V <sub>IN1</sub> , V <sub>IN2</sub> = 2.60V		±12	±20		±30			

1.  $\Delta R_{on} = \max |mS_N - nS_N|$ , where  $m = 1$  and  $n = 2$ ,  $N = 1..3$

2. Flatness is defined as the difference between the maximum and minimum value of ON-resistance as measured over the specified analog signal ranges.

## 3.2 AC Electrical Characteristics

**Table 6. AC Electrical Characteristics** ( $C_L = 35\text{pF}$ ,  $R_L = 50\Omega$ ,  $\text{tr} = \text{tf} \leq 5\text{ns}$ )

Symbol	Parameter	Test Condition		Value						Unit	
		$V_{CC}(\text{V})$		$T_A = 25^\circ\text{C}$			$-40 \text{ to } 85^\circ\text{C}$		$-55 \text{ to } 125^\circ\text{C}$		
				Min.	Typ.	Max.	Min.	Max.	Min.		
$t_{PLH}, t_{PHL}$	Propagation Delay	1.65-1.95			0.45					ns	
		2.3 - 2.7			0.40						
		3.0 - 3.3			0.30						
		3.6 - 4.3			0.30						
$t_{ON}$	TURN-ON time	1.65-1.95	$V_S=0.8\text{V}$		56					ns	
		2.3-2.7	$V_S=1.5\text{V}$		33	50		60			
		3.0-3.3			21	40		50			
		3.6-4.3			19	40		50			
$t_{OFF}$	TURN-OFF time	1.65-1.95	$V_S=0.8$		24					ns	
		2.3-2.7	$V_S=1.5\text{V}$		17	25		40			
		3.0-3.3			14	20		30			
		3.6-4.3			12	20		30			
$t_D$	Break Before Make Time Delay	1.65-1.95	$V_S=0.8$	10	31					ns	
		2.3-2.7	$V_S=1.5\text{V}$	10	22	40		50			
		3.0-3.3		10	18	30		40			
		3.6-4.3		10	7	25		35			
Q	Charge Injection	1.65-1.95	$C_L=100\text{pF}$		25					pC	
		2.3-2.7	$R_L=1\text{MO}$		35						
		3.0-3.3	$V_{GEN}=0\text{V}$		40						
		3.6-4.3	$R_{GEN}=0\Omega$		55						

### 3.3 Analog Switch

**Table 7. Analog Switch Characteristics ( $C_L = 5\text{pF}$ ,  $R_L = 50\Omega$ ,  $T_A = 25^\circ\text{C}$ )**

Symbol	Parameter	Test Condition		Value						Unit	
		$V_{CC} (\text{V})$		$T_A = 25^\circ\text{C}$			$-40 \text{ to } 85^\circ\text{C}$		$-55 \text{ to } 125^\circ\text{C}$		
				Min.	Typ.	Max.	Min.	Max.	Min.		
OIRR	Off Isolation <sup>(1)</sup>	1.65-4.3	$V_S=1\text{V}_{\text{RMS}}$ $f=100\text{kHz}$		-82					dB	
Xtalk	Crosstalk	1.6-4.3	$V_S=1\text{V}_{\text{RMS}}$ $f=100\text{kHz}$		-84					dB	
THD	Total Harmonic Distortion	2.3-4.3	$R_L=600\Omega$ $V_{IN}=2\text{V}_{\text{PP}}$ $f=20\text{Hz to } 20\text{kHz}$		0.03					%	
BW	-3dB Bandwidth	1.65-4.3	$R_L=50\Omega$		100					MHz	
$C_{IN}$	Control Pin Input Capacitance				5					pF	
$C_{Sn(OFF)}$	Sn Port OFF Capacitance	3.3	$f = 1\text{MHz}$		23						
$C_{Sn(ON)}$	Sn Port ON Capacitance	3.3	$f = 1\text{MHz}$		70						
$C_D$	D Port Capacitance when Switch is Enabled	3.3	$f = 1\text{MHz}$		70						

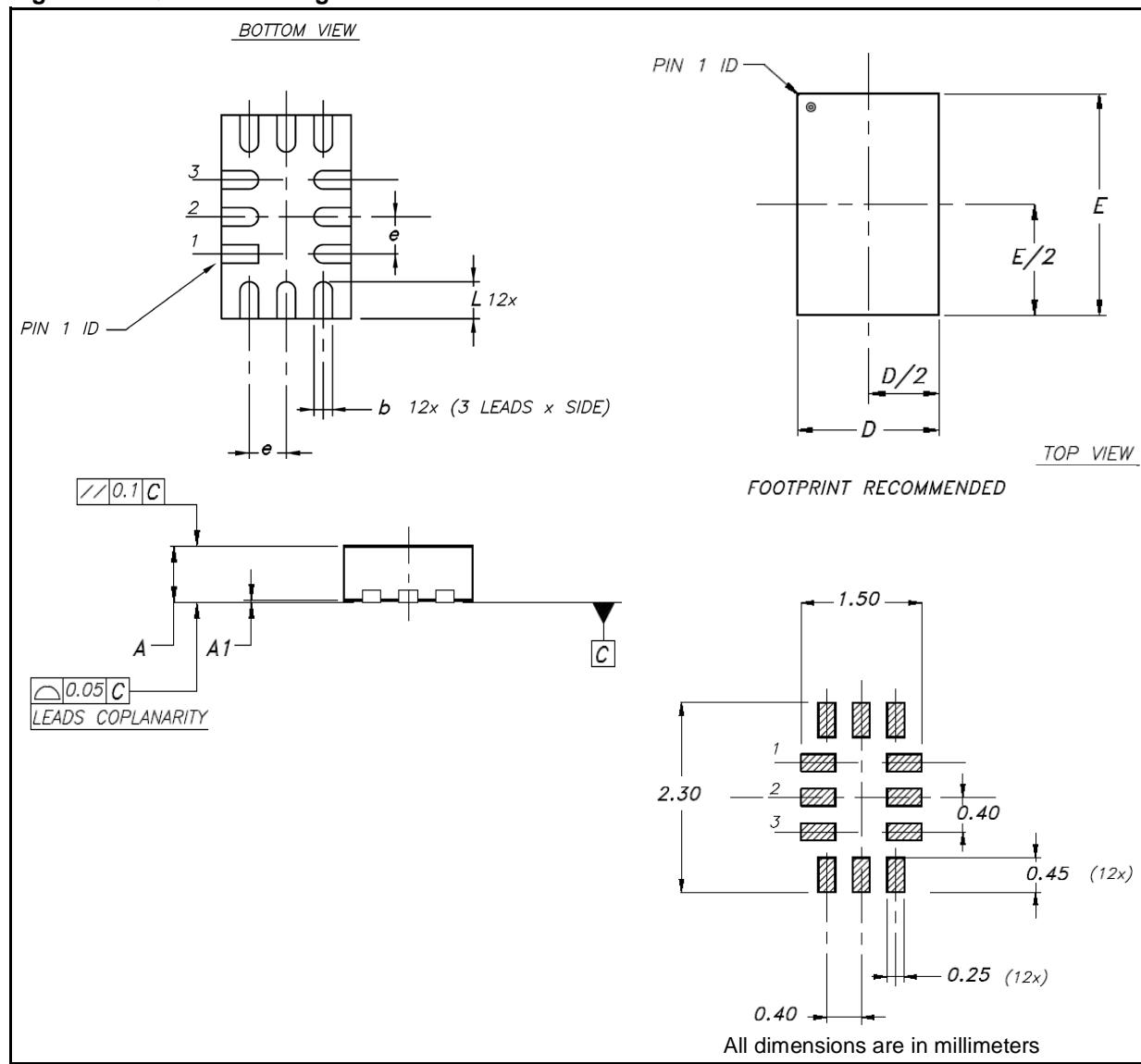
1. OFF Isolation =  $20\log_{10}(V_D/V_S)$ ,  $V_D$  = output,  $V_S$  = input at off switch

## 4 Package Mechanical Data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

**Table 8.** QFN12L (2.2mm x 1.4mm) Mechanical Data

Ref	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.50	0.55	0.60	0.019	0.021	0.023
A1	0	0.02	0.05	0	0.001	0.002
b	0.15	0.20	0.25	0.006	0.007	0.010
D	1.30	1.40	1.50	0.051	0.055	0.059
E	2.10	2.20	2.30	0.082	0.086	0.090
e		0.40			0.015	
L	0.35	0.40	0.45	0.013	0.015	0.017

**Figure 4.** QFN12L Package Dimensions

## 5 Revision History

Date	Revision	Description of Change
22-Dec-2005	1	First Draft
23-Dec-2005	2	Few Changes

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